



**ATTENTION**  
OBSERVE PRECAUTIONS  
FOR HANDLING  
ELECTROSTATIC  
DISCHARGE  
SENSITIVE  
DEVICES

Part Number: AAA3528QWDSURKS

White  
Hyper Red

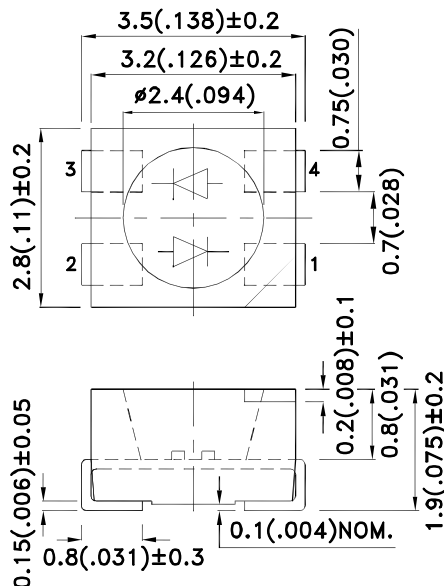
### Features

- Both chips can be controlled separately.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

### Descriptions

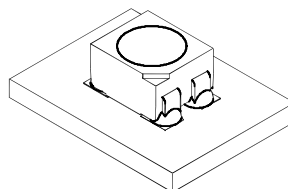
- The source color devices are made with InGaN Light Emitting Diode.
- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

### Package Dimensions



RED  
3 4

WHITE  
2 1



#### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25(0.01)$  unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

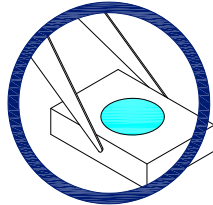


## Handling Precautions

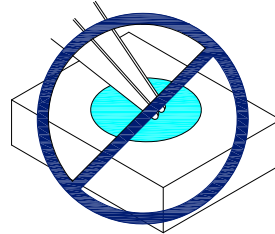
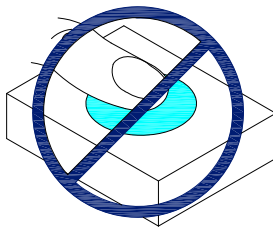
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

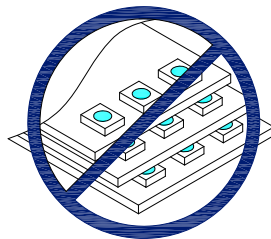
1. Handle the component along the side surfaces by using forceps or appropriate tools.



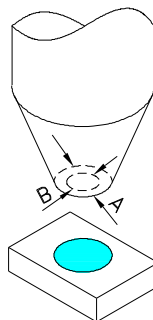
2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as  $H_2S$  might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

## Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
AAA3528QWDSURKS	White (InGaN)	Water Clear	300	450	120°
			*300	*450	
	Hyper Red (AlGaInP)		200	320	
			*55	*100	

### Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.
- \*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

## Electrical / Optical Characteristics at TA=25°C [White]

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
V <sub>F</sub> [1]	Forward Voltage	White	3.3	4.0	V	I <sub>F</sub> =20mA
I <sub>R</sub>	Reverse Current	White		50	uA	V <sub>R</sub> = 5V
X [2]	Chromaticity Coordinates	White	0.31			
Y [2]			0.31			
C	Capacitance	White	100		pF	V <sub>F</sub> =0V;f=1MHz

### Notes:

- 1.Forward Voltage: +/-0.1V.
- 2.Measurement tolerance of the chromaticity coordinates is ±0.01.
- 3.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

## Electrical / Optical Characteristics at TA=25°C [Red]

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ <sub>peak</sub>	Peak Wavelength	Hyper Red	645		nm	I <sub>F</sub> =20mA
λ <sub>D</sub> [1]	Dominant Wavelength	Hyper Red	630		nm	I <sub>F</sub> =20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	28		nm	I <sub>F</sub> =20mA
C	Capacitance	Hyper Red	35		pF	V <sub>F</sub> =0V;f=1MHz
V <sub>F</sub> [2]	Forward Voltage	Hyper Red	1.95	2.5	V	I <sub>F</sub> =20mA
I <sub>R</sub>	Reverse Current	Hyper Red		10	uA	V <sub>R</sub> = 5V

### Notes:

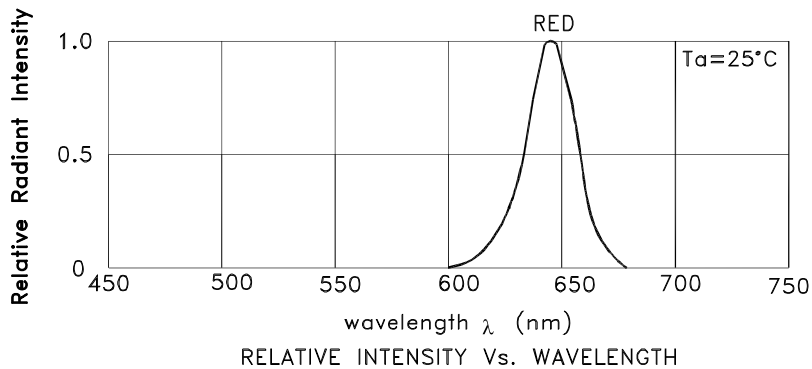
- 1.Wavelength: +/-1nm.
- 2.Forward Voltage: +/-0.1V.
- 3.Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

## Absolute Maximum Ratings at TA=25°C

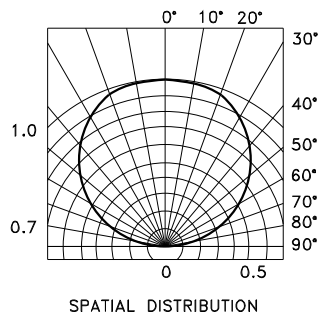
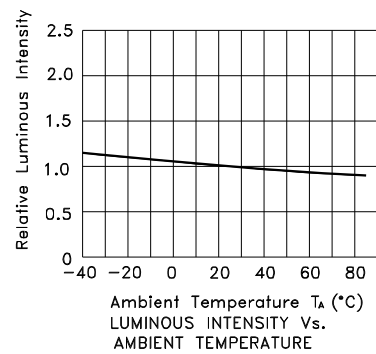
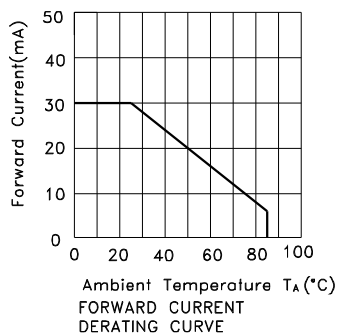
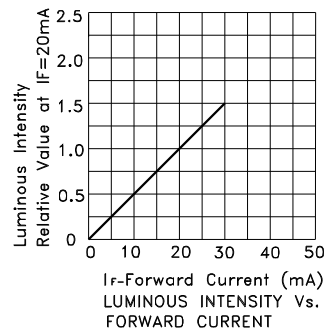
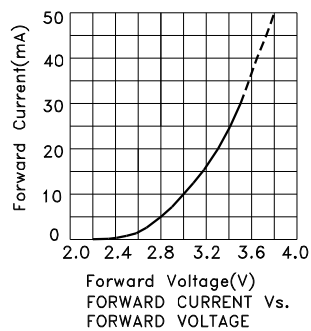
Parameter	White	Hyper Red	Units
Power dissipation	120	75	mW
DC Forward Current	30	30	mA
Peak Forward Current [1]	150	185	mA
Reverse Voltage	5		V
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

### Note:

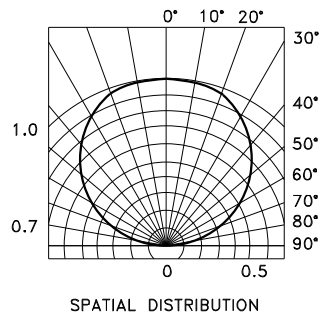
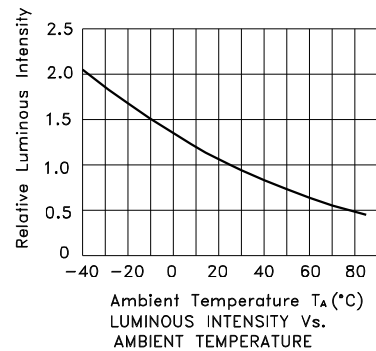
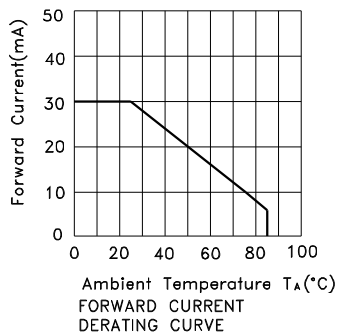
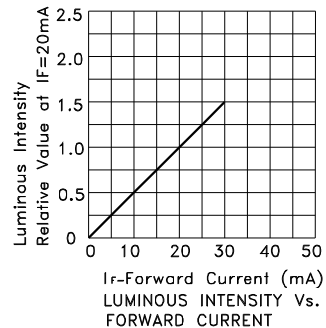
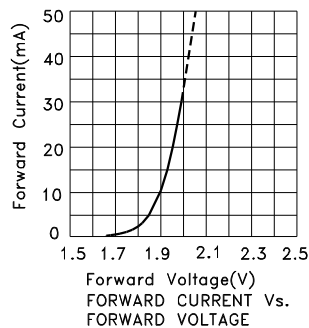
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



## AAA3528QWDSURKS White

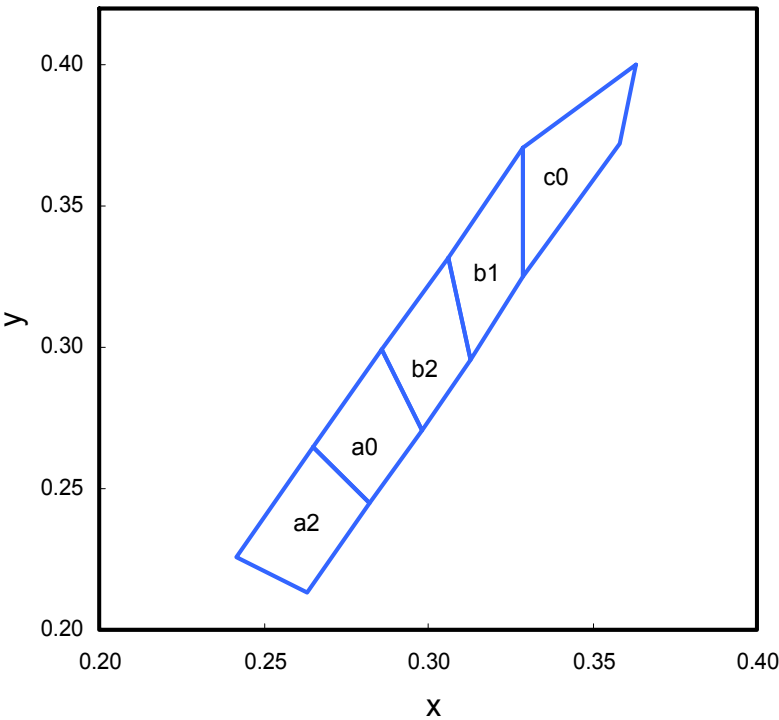


## Hyper Red



AAA3528QWDSURKS

White CIE



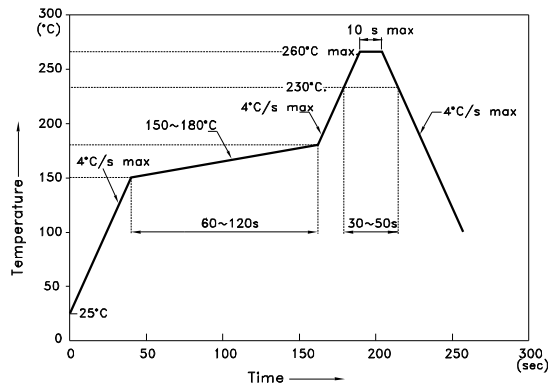
x			y			x			y		
a2	0.263	0.213	a0	0.282	0.245	b2	0.298	0.271	b1	0.313	0.296
	0.282	0.245		0.298	0.271		0.313	0.296		0.329	0.325
	0.265	0.265		0.286	0.299		0.306	0.332		0.363	0.400
	0.242	0.226		0.265	0.265		0.286	0.299		0.329	0.371

Notes:  
Shipment may contain more than one chromaticity regions.  
Orders for single chromaticity region are generally not accepted.  
Measurement tolerance of the chromaticity coordinates is ±0.01.

## AAA3528QWDSURKS

Reflow soldering is recommended and the soldering profile is shown below.  
Other soldering methods are not recommended as they might cause damage to the product.

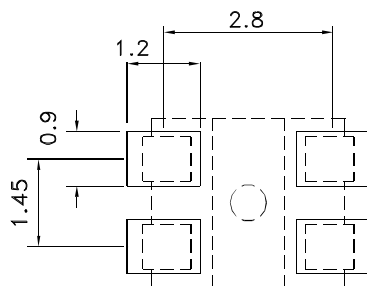
Reflow Soldering Profile For Lead-free SMT Process.



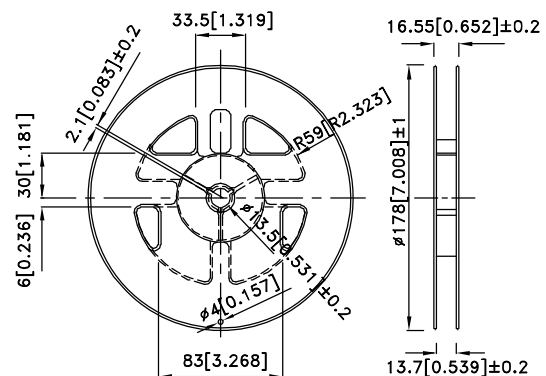
### NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

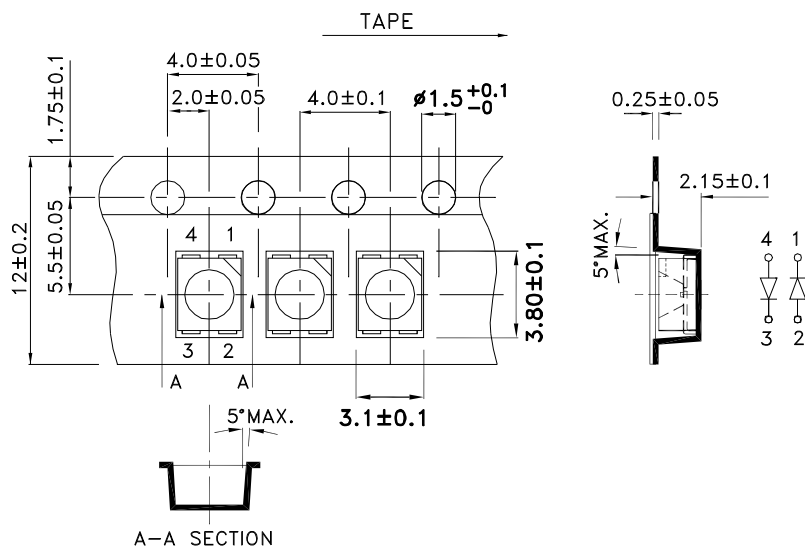
### Recommended Soldering Pattern (Units : mm; Tolerance: $\pm 0.1$ )



### Reel Dimension

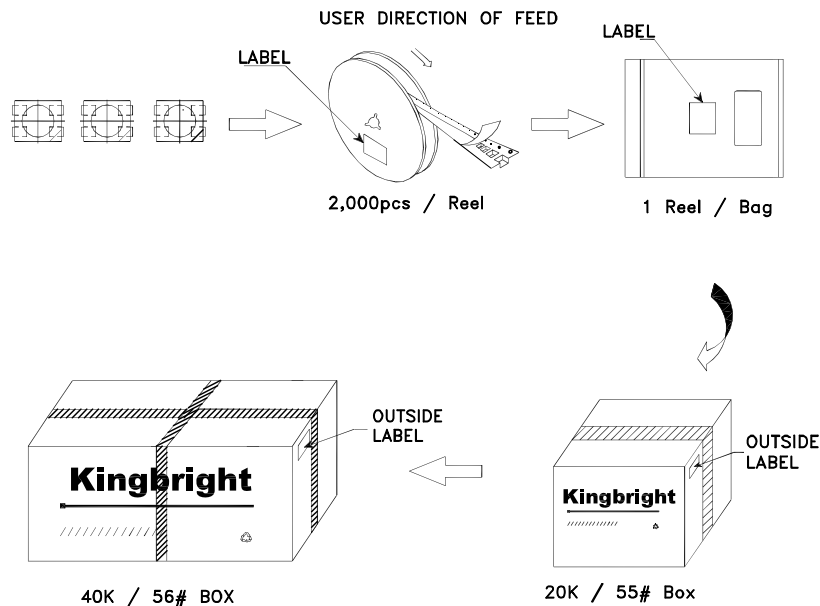


### Tape Dimensions (Units : mm)



## PACKING & LABEL SPECIFICATIONS

AAA3528QWDSURKS



<b>Kingbright</b>	
P/NO: AAA3528XXX	
QTY: 2,000 pcs	Q.C. <span style="border: 1px solid black; border-radius: 50%; padding: 2px;">Q C XX XX XXXX PASSED</span>
S/N: XXXX	
CODE: XXX	
LOT NO:	
RoHS Compliant	

### Terms and conditions for the usage of this document

- 1.The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2.The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 3.When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- 4.The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- 5.The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6.All design applications should refer to Kingbright application notes available at <http://www.KingbrightUSA.com/ApplicationNotes>